

# PACIFIC DISPLAY DEVICES

## **LCD** Component Data Sheet

## Model Number: 16244

16 Character by 2 Line Alphanumeric LCD Assembly With Embedded Controller

## **CONTENTS**

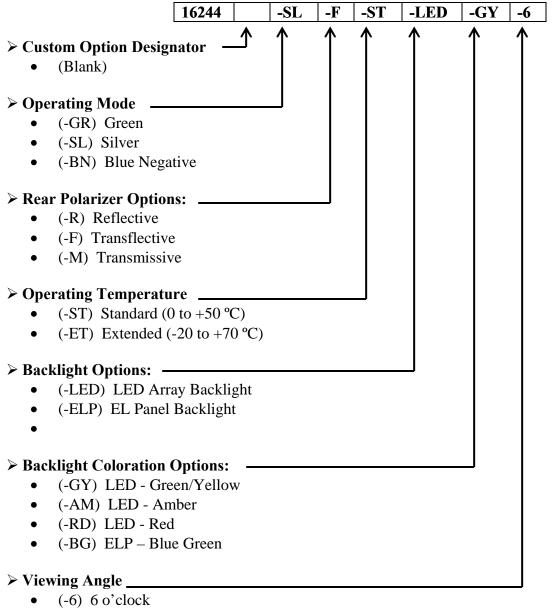
1.	GENERAL INFORMATION	
	1.1 Product Overview	2
	1.2 Part Numbering System	2
	1.3 Absolute Maximum Ratings	3
	1.4 Circuit Block Diagram	3
	1.5 Mechanical Characteristics	3
	1.6 Input Signal Function	4
	1.7 LCM Contrast Control and Bias	4
	1.8 LCD Dimensions	5
2.	ELECTRICAL / OPTICAL CHARACTERISTICS	
	2.1 DC Electrical Characteristics	6
	2.2 AC Electrical Characteristics	6
	2.3 Optical Characteristics	8
	2.4 LED Backlight Characteristics	9
	2.5 EL Panel Backlight Characteristics	9
3.	OPERATING PRINCIPALS AND METHODS	
	3.1 LCD Controller Display and Control Functions	10
	3.2 Display Data RAM Address Map	12
4.	RELIABILITY	13
5.	PRECAUTIONS FOR USING LCD MODULES	14

### **1. GENERAL INFORMATION**

#### **1.1 Product Overview**

- 16 Character x 2 line Alphanumeric Dot Matrix LCD Module
- LCD Controller: Embedded S6A0069 or equivalent alpha-numeric controller
- Multiplexing driving: 1/16 duty, 1/5 bias
- Operating Mode: Super Twisted Nematic (STN) technology
- LCD Module Service Life: 100,000 hours minimum

#### **1.2 Part Numbering System**

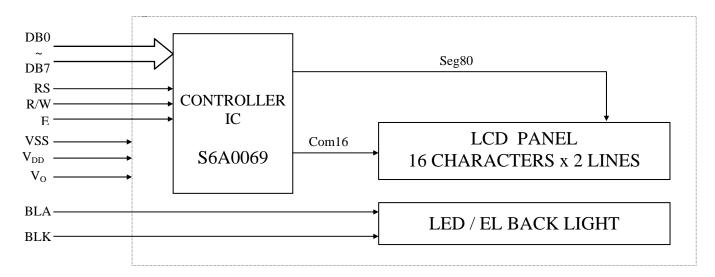


• (-12) 12 0'clock

## **1.3 Absolute Maximum Ratings**

Parameter	Symbol	Min	Max	Unit
Supply voltage for logic	V <sub>DD</sub>	-0.3	7.0	V
Supply voltage for LCD	$V_{DD} - V0$		V <sub>DD</sub> +0.3	V
Input voltage	VI	-0.3	V <sub>DD</sub> +0.3	V
Standard Operating temperature	TOP (-ST)	0	50	°C
Standard Storage temperature	TST (-ST)	-10	60	°C
Extended Operating temperature	TOP (-ET)	-20	70	°C
Extended Storage temperature	TST (-ET)	-30	80	°C
Soldering Temp	Tsolder	20	50	°C

## 1.4 Circuit Block Diagram



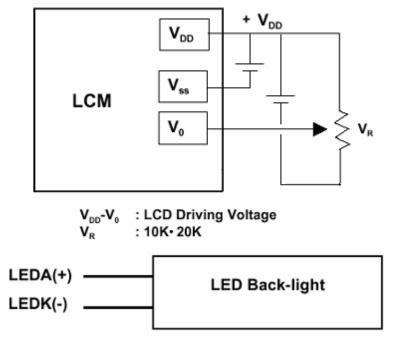
### **1.5 Mechanical Characteristics**

Item	Contents	Unit
Module size (W×H×T)	84.0 x 44.0 x 14.2 Max (w/ LED Backlight)	mm
	84.0 x 44.0 x 10.0 Max (w/ ELP, Reflective)	
Viewing area (W×H)	62.2 x 17.9	mm
Character matrix (W×H)	$5 \times 8$	dots
Character size (W×H)	2.95 x 5.55	mm
Dot size (W×H)	0.55 x 0.65	mm
Dot pitch (W×H)	0.60 x 0.70	mm

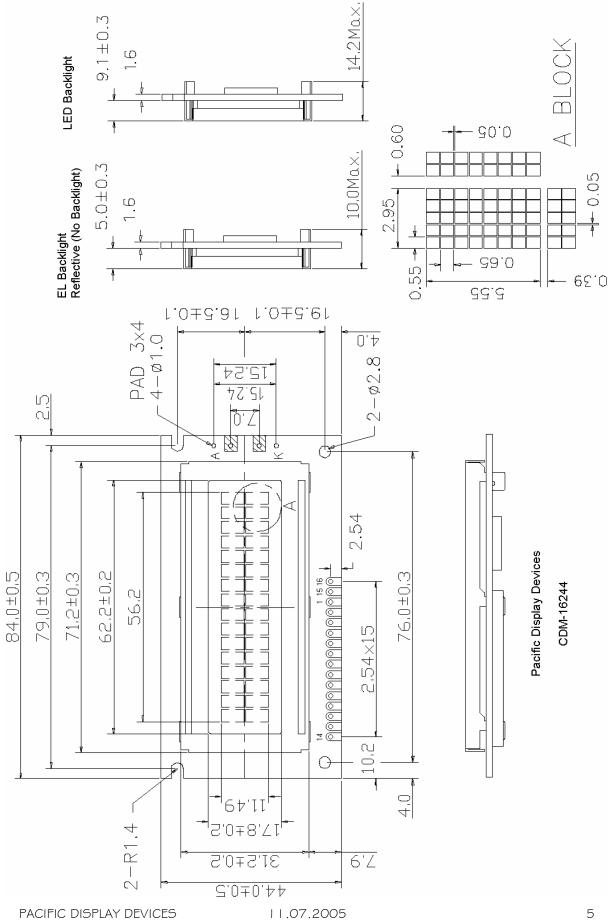
Pin NO.	Symbol	Level	Description		
1	VSS	0V	Ground		
2	VDD	5.0V	Supply voltage for logic		
3	VO		Input voltage for LCD		
4	RS	H/L	H : Data signal, L : Instruction signal		
5	R/W	H/L	H : Read mode, L : Write mode		
6	E	H, H $\rightarrow$ L	Chip enable signal		
7	DB0	H/L	Data bit 0		
8	DB1	H/L	Data bit 1		
9	DB2	H/L	Data bit 2		
10	DB3	H/L	Data bit 3		
11	DB4	H/L	Data bit 4		
12	DB5	H/L	Data bit 5		
13	DB6	H/L	Data bit 6		
14	DB7	H/L	Data bit 7		
15	LED A(+)	4.2V	Back light anode		
16	LED K (-)	0V	Back light cathode		

## **1.6 Input Signal Function**

## 1.7 LCM Contrast Control and Bias



#### SPECIFICATIONS FOR LIQUID CRYSTAL DISPLAY MODULE **1.8 LCM Dimensions**



## 2. ELECTRICAL / OPTICAL CHARACTERISTICS

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Supply voltage for logic	V <sub>DD</sub>		4.5	5.0	5.5	V
Supply current for logic	I <sub>DD</sub>			1.38	3	mA
		0°C		5.10		V
Operating voltage for LCD*	$V_{DD}$ - $V_O$	25°C		4.50		V
		50°C		4.30		V
Input voltage ' H ' level	V <sub>IH</sub>		2.2		VDD	V
Input voltage ' L ' level	V <sub>IL</sub>		-0.3		0.6	V

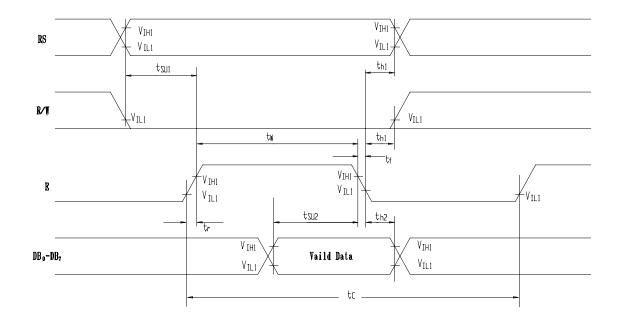
#### **2.1 DC Electrical Characteristics** $(V_{DD} = +5V \pm 10\%, V_{SS} = 0V, Ta = 25^{\circ}C)$

\*Note: -ET temp range will require up to maximun 8V biasing and require a minimum external voltage supply of -3V @-20°C.

#### **2.2 AC Electrical Characteristics**

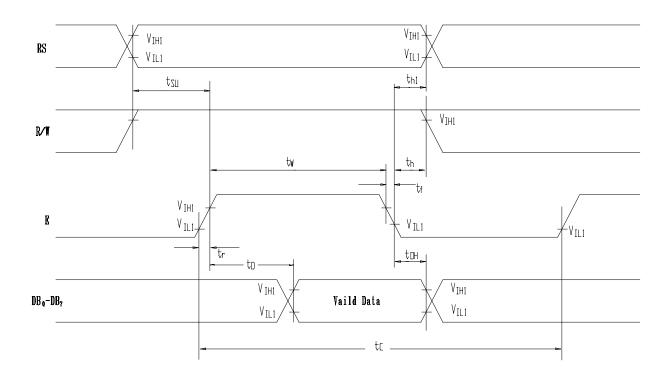
#### • Write Mode

Characteristic	Symbol	Min.	Тур.	Max.	Unit	Test pin
E cycle time	t <sub>C</sub>	500			ns	Е
E rise time	t <sub>r</sub>			25	ns	Е
E fall time	t <sub>f</sub>			25	ns	Е
E pulse width (High, Low)	tw	220			ns	Е
R/W and RS set-up time	t <sub>SU1</sub>	40			ns	R/W, RS
R/W and RS hold time	t <sub>h1</sub>	10			ns	R/W, RS
Data set-up time	t <sub>SU2</sub>	60			ns	$DB_0 \sim DB_7$
Data hold time	t <sub>h2</sub>	10			ns	$DB_0 \sim DB_7$



#### • Read Mode

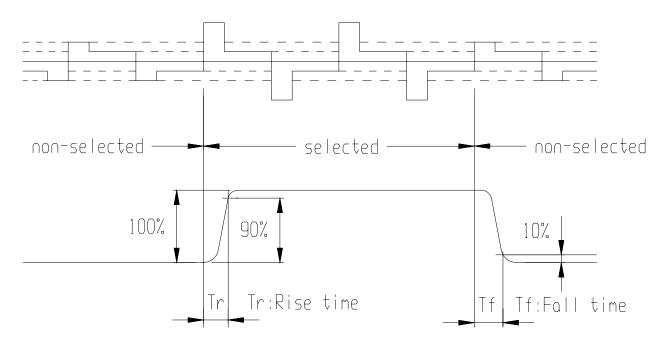
Characteristic	Symbol	Min.	Тур.	Max.	Unit	Test pin
E cycle time	t <sub>C</sub>	500			ns	Е
E rise time	t <sub>r</sub>			25	ns	Е
E fall time	t <sub>f</sub>			25	ns	Е
E pulse width	t <sub>w</sub>	220			ns	Е
R/W and RS set-up time	t <sub>SU</sub>	40			ns	R/W, RS
R/W and RS hold time	t <sub>h</sub>	10			ns	R/W, RS
Data output delay time	t <sub>D</sub>			120	ns	$DB_0 \sim DB_7$
Data hold time	t <sub>DH</sub>	20			ns	$DB_0 \sim DB_7$



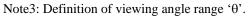
## **2.3 Optical Characteristics** $(V_{OP} = 4.7V, Ta = 25^{\circ}C)$

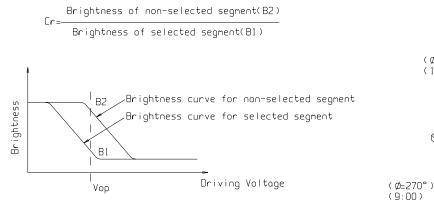
Item	Symbol	Condition	Min	Тур	Max	Unit	Remarks	Note
Pasponsa tima	Tr			250	380	ms		1
Response time	Tf			200	300	ms		1
Contrast Ratio	Cr		3	5.0				2
Frame Frequency	$f_{\rm F}$			64		Hz		2
			25			deg	$\emptyset = 90^{\circ}$	3
Viewing angle	θ	$C_{\pi} \geq 2$	33			deg	$\emptyset = 270^{\circ}$	3
range		$Cr \ge 2$	52			deg	$\emptyset = 0^{\circ}$	3
			33			deg	$\emptyset = 180^{\circ}$	3

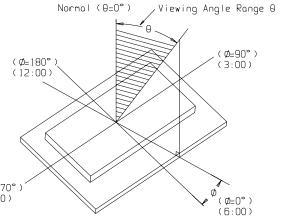
Note1: Definition of response time.



#### Note2: Definition of contrast ratio 'Cr'







## 2.4 LED Backlight Characteristics

Itom	Symbol	Conditions		Standard				
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit		
Forward Voltage	$V_{\rm f}$	Ta= 25 °C	3.8	4.1	4.4	VDC		
Forward Current	I <sub>F</sub>	Ta= 25 °C		120	260	mA		
Reverse Voltage	V <sub>R</sub>	Ta= 25 °C		8		V		

### ■ Yellow-Green LED Operating Characteristics (5V - Array Lit)

## ■ Life (Array or Edge Lit)

Item	Conditions	Stan	Standard				
Item	Conditions	Min.	Max.	Unit			
Life	Ta= 25 °C	100,000		hrs			

## 2.5 EL Panel Backlight Characteristics

## ■ Blue-Green EL Panel Operating Characteristics:

Conditions		Unit			
Conditions	Min.	Тур.	Max.	Unit	
100VAC RMS, 400Hz Ta: 25°C		2.5	3.9	mA	
		100	150	VAC RMS	
		400	1000	Hz	
	-35°C		+50°C	°C	
	-40°C		+60°C	°C	
100VAC RMS, 400Hz	40	50		cd/m <sup>2</sup>	
Ta: 25°C	3500			Hrs	
	Ta: 25°C    100VAC RMS, 400Hz	Min.           100VAC RMS, 400Hz Ta: 25°C                                    100VAC RMS, 400Hz         40	Min.         Typ.           100VAC RMS, 400Hz Ta: 25°C          2.5             100             400            -35°C            100VAC RMS, 400Hz         40         50	Conditions         Min.         Typ.         Max.           100VAC RMS, 400Hz Ta: 25°C          2.5         3.9            100         150             400         1000             400         1000             40°C            100VAC RMS, 400Hz         40         50	

\*Note: half life is defined as Luminance being reduced by 50%

## 3. OPERATING PRINCIPALS AND METHODES

## Control and Display Command

Control and Display Command																					
Command	RS	R/W	DB <sub>7</sub>	DB <sub>6</sub>	DB <sub>5</sub>	DB <sub>4</sub>	DB <sub>3</sub>	DB <sub>2</sub>	DB <sub>1</sub>	DB <sub>0</sub>	Exe Time f=250khz	Remark									
Display Clear	L	L	L	L	L	L	L	L	L	Н	1.64ms										
Return Home	L	L	L	L	L	L	L	L	H	X	1.64ms	Cursor move to first digit									
Entry Mode Set	L	L	L	L	L	L	L	Н	I/D	SH	42µs	• I/D : Set cursor move direction									
												I/D H Increase									
												L Decrease									
												• SH : Specifies shift of display									
												H Display is shifted									
												SH L Display is not shifted									
Display On/Off	L	L	L	L	L	L	Н	D	С	В	42µs	• Display									
Display on/on	2	Ľ	2	1	2			D	e	D	+2μ3										
												D H Display on									
												L Display off									
											• Cursor										
												H Cursor on									
														C L Cursor off							
															Blinking						
												H Blinking on B									
												L Blinking off									
Shift	L	L	L	L	L	Н	S/C	R/L	Х	Х	42µs	H Display shift									
													S/C L Cursor move								
														H Right shift							
												R/L L Left shift									
Set Function	L	L	L	L	Н	DL	N	F	Х	Х	42µs	H 8 bits interface									
								1	I		I	I									DL L 4 bits interface
												H 2 line display									
												N									
												L 1 line display									
												F H 5 X 10 dots									
												L 5 X 7 dots									
Set Cg Ram Address	L	L	L	Н			CG RAN	/1 addres	s		42µs	CG RAM Data is sent and									
-						(corres	ponds to	cursor a			-	received after this setting									
Set Dd Ram Address	L	L	Н			DD	RAM ad	dress			42µs	DD RAM Data is sent and received after this setting									
Read Busy Flag &	L	Н	BF				Counter				0µs	H Busy									
Address		both DD & CG RAM address		BF																	
												L Ready									
												<ul> <li>Reads BF indication internal operating is being performed</li> </ul>									
												- Reads addr counter contents									
Write Data	Н	L					e Data				46µs	Write data into DD or CG RAM									
Read Data X : Don't care	Н	Н	L		Read Data					46µs	Read data from DD or CG RAM										

X : Don't care

IUI	tializ	ing t	oy In	struc	tion					
	Power On									
										_
	Wait f	for mo	re tha	n 15m	s after	r VDE	) rises	to 4.5	V	
										7
RS				DB5						BF cannot be checked before this instruction.
0	0	0	0	1	1	*	*	*	*	Function Set
				•						1
			Wait	for mo	re tha	n 4.1r	ns			
DC	DAV	<b>DD7</b>		DD5		DD2	002	DD1	DDO	DE connet he checked hefers this instruction
RS 0	K/W	0	0	DB5 1	DB4	NB3	DB2 *	* DB1	* DB0	BF cannot be checked before this instruction. Function Set
0	0	0	0	1	1				•	Function Set
			Wait	for mo	ra tha	n 100				1
			vv alt 1	01 110		11 100	us			1
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	BF cannot be checked before this instruction.
0	0	0	0	1	1	*	*	*	*	Function Set
-	-	-	-							1
					i					BF can be checked after following
					İ					instruction.
										When BF is not checked, the waiting time
										between instructions is longer than execution
										instruction time.
										1
RS				DB5				DB1 *	DB0 *	Function Set (Specify the number of display
0	0	0	0	1	1	Ν	F	*	*	lines and character font.) The number of
										display lines and character font cannot be
0	0	0	0	0	0	1	0	0	0	changed afterwards. Display Off
0	0	0	0	0	0	0	0	0	1	Display Clear
0	0	0	0	0	0	0	1	I/D	S	Entry Mode Set
0	0	0	0	0		0	1	Ι/D	5	Entry Wode Set
					$\downarrow$					

## • Initializing by Instruction

## 3.2 Display Data RAM Address Map

Upper-4 Lower Bits	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
4 Bia xxxxx00000	CG RAM (1)			Ø	Ð	P	•	P					2	Ξ.	ά	p
xxxx0001	(2)		•	1	A	Q	a	9				7	Ŧ	4	ä	q
xxxx0010	(3)		11	2	В	R	Ь	r			ſ	4	'n	x	F	θ
xxxx0011	(4)		Ħ	3	С	5	C	S			L	7	Ŧ	ŧ	ε	60
xxxx0100	(5)		\$	4	D	T	C	t.			٩	Ι	ŀ	Þ	μ	Ω
xxxx0101	(6)		7	5	E	U	e	u				7	<del>,</del>	1	G	ü
xxxx0110	(7)		8.	6	F	Ų	f	V			Ţ	Ħ	-	Ξ	ρ	Σ
xxxx0111	(8)		7	7	G	W	9	W			7	Ŧ	7	7	9	π
xxxx1000	(1)		C	8	Η	X	h	X			4	2	*	Ņ	<b>.</b> ,	X
xxxx1001	(2)		)	9	Ι	Y	i	Ч			÷	ን	J	Ib	-1	Ч
xxxx1010	(3)		*		J	Z	j	Z			I		Ú	V	j	Ŧ
xxxx1011	(4)		÷	7	K		k	{			7	Ħ	F		×	Б
xxxx1100	(5)		7	<		¥	1				Þ	Ð	7	7	4	Ħ
xxxx1101	(6)		—		М		M	}			ュ	Z	ን	2	Ł	÷
xxxx1110	(7)			>	Ν	^	n	÷			Э	Þ			'n	
xxxx1111	(8)		/	?	0	_	0	÷			IJ	У	7		Ö	

## LCD Character Location map

Characters	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
First line	00H	01H	02H	03H	04H	05H	06H	07H	08H	09H	0AH	0BH	0CH	0DH	0EH	0FH
Second line	40H	41H	42H	43H	44H	45H	46H	47H	48H	49H	4AH	4BH	4CH	4DH	4EH	4FH

## 4. RELIABILITY

		<b>Environmental Test</b>		
No	Test Item	Content of Test	Test Condition	Applicable Standard
1	High temperature storage	Endurance test applying the high storage temperature for a long time.	80 °C 200 hrs	
2	Low temperature storage	Endurance test applying the low storage temperature for a long time.	-30 °C 200 hrs	
3	High temperature operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70 °C 200 hrs	
4	Low temperature operation	Endurance test applying the electric stress under low temperature for a long time.	-20 °C 200 hrs	
5	High temperature / Humidity storage	Endurance test applying the high temperature and high humidity storage for a long time.	80 °C , 90 %RH 96 hrs	MIL-202E-103B JIS-C5023
6	High temperature / Humidity operation	Endurance test applying the electric stress (Voltage & Current) and temperature / humidity stress to the element for a long time.	70 °C , 90 %RH 96 hrs	MIL-202E-103B JIS-C5023
7	Temperature cycle	Endurance test applying the low and high temperature cycle. $\begin{array}{c} -20^{\circ}C \\ 30\text{min.} \end{array} \xrightarrow{25^{\circ}C} 5\text{min.} \end{array} \xrightarrow{70^{\circ}C} 30\text{min.} \xrightarrow{1}$	-20°C / 70°C 10 cycles	
		Mechanical Test		
8	Vibration test	Endurance test applying the vibration during transportation and using.	$10 \sim 22 \text{Hz} \rightarrow 1.5 \text{mmp-p}$ $22 \sim 500 \text{Hz} \rightarrow 1.5 \text{G}$ Total 0.5 hrs	MIL-202E-201A JIS-C5025 JIS-C7022-A-10
9	Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sign wave 11 msedc 3 times of each direction	MIL-202E-213B
10	Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115 mbar 40 hrs	MIL-202E-105C
		Others		
11	Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V , RS=1.5 kΩ CS=100 pF 1 time	MIL-883B- 3015.1

\*\*\* Supply voltage for logic system = VDD. Supply voltage for LCD system = Operating voltage at 25°C

## LCD Panel Service Life

#### Definition of panel service life

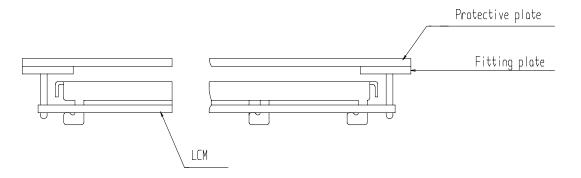
- 100,000 hours minimum at  $25^{\circ} \text{ C} \pm 10\%$
- Contrast becomes 30% of initial value
- Current consumption becomes three times higher than initial value
- Remarkable alignment deterioration occurs in LCD cell layer
- Unusual operation occurs in display functions

#### **5. PRECAUTIONS FOR USING LCD MODULES**

#### **Installing LCD Modules**

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ±0.1 mm.

#### **Precaution for Handing LCD Modules**

Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- 1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.
- 2) Do not alter, modify or change the shape of the tab on the metal frame.
- 3) Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- 4) Do not damage or modify the pattern writing on the printed circuit board.
- 5) Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- 6) Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- 7) Do not drop, bend or twist LCM.

#### **Electro-Static Discharge Control**

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

- 1) Make certain that you are grounded when handing LCM.
- 2) Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
- 3) When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
- 4) When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- 5) As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
- 6) To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

#### Precaution for soldering to the LCM

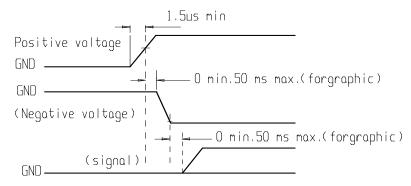
- Observe the following when soldering lead wire, connector cable and etc. to the LCM.
   a) Soldering iron temperature : 280°C ± 10°C.
- b) Soldering time : 3-4 sec.2) Solder : eutectic solder.
- 2) Solder : eutectic solder.

#### SPECIFICATIONS FOR LIQUID CRYSTAL DISPLAY MODULE

- 3) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 5) When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

#### **Precautions for Operation**

- 1) Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.
- 2) Driving the LCD in the voltage above the limit shortens its life.
- 3) Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
- 4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 5) Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40°C , 50% RH.
- 6) When turning the power on, input each signal after the positive/negative voltage becomes stable.



#### <u>Safety</u>

• If the LCD panel breaks, be careful not to get the liquid crystal in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and plenty of water.

#### <u>Handling</u>

- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it or impact.
- If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents :
  - Isopropyl alcohol
  - Ethyl alcohol
- Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
  - o Water
  - o Ketone
  - o Aromatic solvents
- Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- Do not attempt to disassemble or process the LCD module.
- NC terminal should be open. Do not connect anything.
- If the logic circuit power is off, do not apply the input signals. PACIFIC DISPLAY DEVICES II.07.2005

#### SPECIFICATIONS FOR LIQUID CRYSTAL DISPLAY MODULE

- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - Be sure to ground the body when handling the LCD modules.
  - Tools required for assembling, such as soldering irons, must be properly grounded.
  - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
  - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

#### **Storage**

- When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps
- Store the module in a dark place where the temperature is  $25 \,^{\circ}C \pm 10 \,^{\circ}C$  and the humidity below 65% RH.
- Do not store the module near organic solvents or corrosive gases.
- Do not crush, shake, or jolt the module (including accessories).

#### Cleaning

- Do not wipe the polarizing plate with a dry cloth, as it may scratch the surface.
- Wipe the module gently with soft cloth soaked with a petroleum benzene.
- Do not use ketonic solvents (ketone and acetone) or aromatic solvents (toluene and xylene), as they may damage the polarizing plate.

#### **Others:**

- Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
  - Exposed area of the printed circuit board.
  - Terminal electrode sections.